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Team Nexperia

# IP4786CZ32S

DVI and HDMI interface ESD and overcurrent protection, DDC/CEC buffering, hot plug detect and backdrive protection

**Rev. 3 — 7 January 2015** 

**Product data sheet** 

# 1. General description

The IP4786CZ32S is designed to protect High-Definition Multimedia Interface (HDMI) transmitter host interfaces. It includes HDMI 5 V overcurrent / overvoltage protection, Display Data Channel (DDC) buffering and decoupling, Hot Plug Detect (HPD), backdrive protection, Consumer Electronic Control (CEC) buffering and decoupling, and  $\pm 12$  kV contact ElectroStatic Discharge (ESD) protection for all external I/Os in accordance with the IEC 61000-4-2, level 4 standard.

The IP4786CZ32S incorporates Transmission Line Clamping (TLC) technology on the high-speed Transition-Minimized Differential Signaling (TMDS) lines to simplify routing and help reduce impedance discontinuities. All TMDS lines are protected by an impedance-matched diode configuration that minimizes impedance discontinuities caused by typical shunt diodes.

The enhanced 60 mA overcurrent / overvoltage linear regulator guarantees HDMI-compliant 5 V output voltage levels with up to 6.5 V inputs.

The DDC lines use a new buffering concept which decouples the internal capacitive load from the external capacitive load for use with standard Complementary Metal Oxide Semiconductor (CMOS) or Low Voltage Transistor-Transistor Logic (LVTTL) I/O cells down to 1.8 V. This buffering also redrives the DDC and CEC signals, allowing the use of longer or cheaper HDMI cables with a higher capacitance. The internal hot plug detect module simplifies the application of the HDMI transmitter to control the hot plug signal.

All lines provide appropriate integrated pull-ups and pull-downs for HDMI compliance and backdrive protection to guarantee that HDMI interface signals are not pulled down if the system is powered down or enters Standby mode. Only a single external capacitor is required for operation.

### 2. Features and benefits

- HDMI 2.0 and all backward compatible standards are supported
- 6.0 Gbps TMDS Bit Rate (600 Mcsc TMDS Character Rate) compatible
- Supports Ultra High-Definition (UHD) 4K (2160p) 60 Hz display modes
- Impedance matched 100  $\Omega$  differential transmission line ESD protection for TMDS lines ( $\pm 10~\Omega$ ). No Printed-Circuit Board (PCB) pre-compensation required
- Simplified flow-through routing utilizing less overall PCB space
- DDC capacitive decoupling between system side and HDMI connector side and buffering to drive cable with high capacitive load (> 700 pF/25 m)
- All external I/O lines with ESD protection of at least  $\pm 12$  kV, exceeding the IEC 61000-4-2, level 4 standard



# **DVI and HDMI interface ESD and overcurrent protection**

- Hot plug detect module
- $\blacksquare$  CEC buffering and isolation, with integrated backdrive-protected 26 k $\Omega$  pull-up
- Robust ESD protection without degradation after repeated ESD strikes
- Highest integration in a small footprint, PCB level, optimized RF routing, 32-pin HVQFN leadless package

# 3. Applications

- The IP4786CZ32S can be used for a wide range of HDMI source devices, consumer and computing electronics:
  - ◆ Tablet and notebook PCs
  - Portable Media Players
  - Digital Still Cameras (DSC)
  - ◆ High-Definition (HD) and Standard-Definition (SD) Blu-ray and DVD players
  - Set-top boxes (STB)
  - ◆ PC graphic cards
  - Game consoles
  - ◆ HDMI picture performance quality enhancer modules
  - Digital Visual Interface (DVI)

# 4. Ordering information

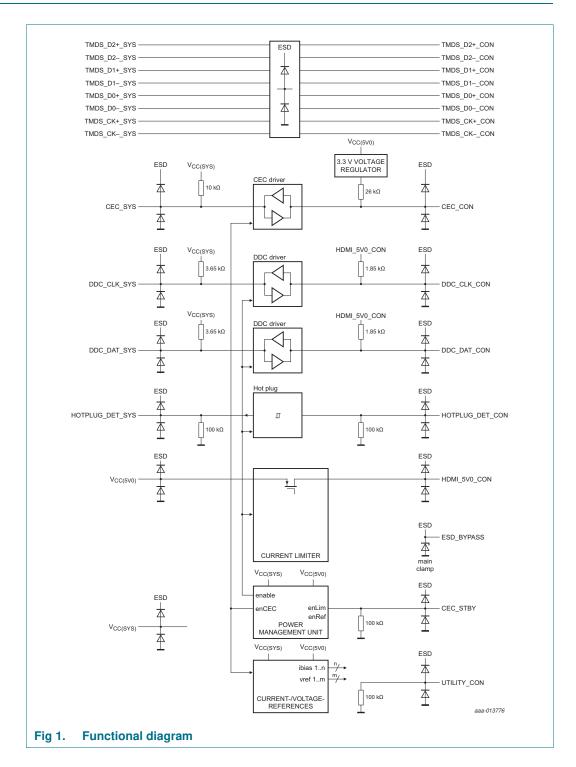
Table 1. Ordering information

Type number	Package	kage						
Name Description V								
IP4786CZ32S		plastic thermal enhanced extremely thin quad flat package; no leads; 32 terminals; body 4 $\times$ 4 $\times$ 0.5 mm	SOT1318-1					

IP4786CZ32S

#### **DVI and HDMI interface ESD and overcurrent protection**

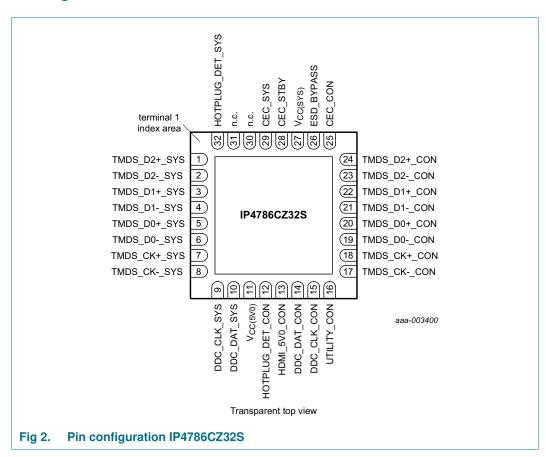
# 5. Functional diagram



#### **DVI and HDMI interface ESD and overcurrent protection**

# 6. Pinning information

### 6.1 Pinning



# 6.2 Pin description

Table 2. Pin description

Pin	Name	Description
1	TMDS_D2+_SYS	TMDS to ASIC inside system
2	TMDS_D2SYS	TMDS to ASIC inside system
3	TMDS_D1+_SYS	TMDS to ASIC inside system
4	TMDS_D1SYS	TMDS to ASIC inside system
5	TMDS_D0+_SYS	TMDS to ASIC inside system
6	TMDS_D0SYS	TMDS to ASIC inside system
7	TMDS_CK+_SYS	TMDS to ASIC inside system
8	TMDS_CKSYS	TMDS to ASIC inside system
9	DDC_CLK_SYS	DDC clock system side
10	DDC_DAT_SYS	DDC data system side
11	V <sub>CC(5V0)</sub>	5 V supply input
12	HOTPLUG_DET_CON	hot plug detect connector side
13	HDMI_5V0_CON	5 V overcurrent out to connector

IP4786CZ32S

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### **DVI and HDMI interface ESD and overcurrent protection**

 Table 2.
 Pin description ...continued

Pin	Name	Description
14	DDC_DAT_CON	DDC data connector side
15	DDC_CLK_CON	DDC clock connector side
16	UTILITY_CON	utility line ESD protection
17	TMDS_CKCON	TMDS ESD protection to connector
18	TMDS_CK+_CON	TMDS ESD protection to connector
19	TMDS_D0CON	TMDS ESD protection to connector
20	TMDS_D0+_CON	TMDS ESD protection to connector
21	TMDS_D1CON	TMDS ESD protection to connector
22	TMDS_D1+_CON	TMDS ESD protection to connector
23	TMDS_D2CON	TMDS ESD protection to connector
24	TMDS_D2+_CON	TMDS ESD protection to connector
25	CEC_CON	CEC signal connector side
26	ESD_BYPASS	ESD bias voltage
27	V <sub>CC(SYS)</sub>	supply voltage for level shifting
28	CEC_STBY	CEC Standby mode control (LOW for lowest power, CEC-only mode)
29	CEC_SYS	CEC I/O signal system side
30	n.c.	not connected
31	n.c.	not connected
32	HOTPLUG_DET_SYS	hot plug detect system side
ground pad	GND	ground

# 7. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC(5V0)</sub>	supply voltage (5.0 V)			GND - 0.5	6.5	V
VI	input voltage	I/O pins		GND - 0.5	5.5	V
V <sub>ESD</sub>	electrostatic discharge	IEC 61000-4-2, level 4 (contact)	[1]	-	±12	kV
	voltage	IEC 61000-4-2, level 1 (contact)	[2]	-	±2	kV
P <sub>tot</sub>	total power dissipation	DDC operating at 100 kHz; CEC operating at 1 kHz; 50 % duty cycle; CEC_STBY = HIGH; no current at HDMI_5V0_CON		-	50	mW
		DDC and CEC bus in idle mode; CEC_STBY = HIGH; no current at HDMI_5V0_CON		-	3.0	mW
		DDC and CEC bus in idle mode; CEC_STBY = LOW		-	1.0	mW
T <sub>amb</sub>	ambient temperature			-25	+85	°C
T <sub>stg</sub>	storage temperature			-55	+125	°C

<sup>[1]</sup> Connector-side pins (typically denoted with "\_CON" suffix) to ground.

 $<sup>[2] \</sup>quad \text{System-side pins: CEC\_SYS, DDC\_DAT\_SYS, DDC\_CLK\_SYS, HOTPLUG\_DET\_SYS, CEC\_STBY, } \\ V_{CC(SYS)} \text{ and } V_{CC(5V0)}. \\ [2] \quad \text{System-side pins: CEC\_SYS, DDC\_DAT\_SYS, DDC\_CLK\_SYS, HOTPLUG\_DET\_SYS, CEC\_STBY, } \\ V_{CC(SYS)} \text{ and } V_{CC(5V0)}. \\ [2] \quad \text{System-side pins: CEC\_SYS, DDC\_DAT\_SYS, DDC\_CLK\_SYS, HOTPLUG\_DET\_SYS, CEC\_STBY, } \\ V_{CC(SYS)} \text{ and } V_{CC(SYS)}. \\ [2] \quad \text{System-side pins: CEC\_SYS, DDC\_DAT\_SYS, DDC\_CLK\_SYS, HOTPLUG\_DET\_SYS, CEC\_STBY, } \\ V_{CC(SYS)} \text{ and } V_{CC(SYS)}. \\ V_{CC(SYS)} \text{ and$ 

#### DVI and HDMI interface ESD and overcurrent protection

#### 8. Static characteristics

Table 4. Supplies

 $T_{amb} = -25$  °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC(5V0)</sub>	supply voltage (5.0 V)	[1]	4.5	5.0	6.5	V
V <sub>CC(SYS)</sub>	system supply voltage		1.62	3.3	5.5	V

<sup>[1]</sup> The IP4786CZ32S contains a 5 V voltage regulator function for higher input voltages. Any input voltage of 4.925 V < V<sub>CC(5V0)</sub> < 6.50 V provides HDMI-compliant output levels of 4.8 V to 5.3 V on HDMI\_5V0\_CON.</p>

Table 5. TMDS protection circuit

 $T_{amb} = -25$  °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TMDS chan	nel						
$Z_{i(dif)}$	differential input impedance	TDR measured; t <sub>r</sub> = 200 ps		90	100	110	Ω
C <sub>eff</sub>	effective capacitance	equivalent shunt capacitance for TDR minimum; t <sub>r</sub> = 200 ps	[1][2]	-	0.6	-	pF
Protection of	liode						
$V_{BRzd}$	Zener diode breakdown voltage	I = 1.0 mA		6.0	-	9.0	V
r <sub>dyn</sub>	dynamic resistance	surge; I = 1.0 A; IEC 61000-4-5/9					
		positive transient		-	1.0	-	Ω
		negative transient		-	1.0	-	Ω
		TLP	[3]				
		positive transient		-	1.0	-	Ω
		negative transient		-	1.0	-	Ω
I <sub>bck</sub>	back current	$V_{CC(5V0)} < V_{ch(TMDS)}$	[4][5]	-	0.1	1.0	μΑ
I <sub>LR</sub>	reverse leakage current	$V_1 = 3.0 \text{ V}$		-	1.0	-	μΑ
V <sub>F</sub>	forward voltage			-	0.7	-	٧
V <sub>CL(ch)trt(pos)</sub>	positive transient channel clamping voltage	100 ns TLP; 50 $\Omega$ pulser at 50 ns		-	8.0	-	V

- [1] This parameter is guaranteed by design.
- [2] Capacitive dip at HDMI Time Domain Reflectometer (TDR) measurement conditions.
- [3] ANSI-ESD SP5.5.1-2004, ESD sensitivity testing Transmission Line Pulse (TLP) component level method 50 TDR.
- [4] Signal pins:
  - TMDS\_D0+\_CON, TMDS\_D0-\_CON, TMDS\_D1+\_CON, TMDS\_D1-\_CON, TMDS\_D2+\_CON, TMDS\_D2-\_CON, TMDS\_CK+\_CON, TMDS\_CK-\_CON, TMDS\_D0+\_SYS, TMDS\_D0-\_SYS, TMDS\_D1+\_SYS, TMDS\_D1-\_SYS, TMDS\_D2+\_SYS, TMDS\_D2-\_SYS, TMDS\_CK+\_SYS and TMDS\_CK-\_SYS.
- [5] Backdrive current from TMDS\_x\_SYS and TMDS\_x\_CON pins to local V<sub>CC(5V0)</sub> bias rail at power-down. Device does not block backdrive current leakage through the device to/from ASIC I/O pins connected to TMDS\_x\_SYS pins.

#### **DVI and HDMI interface ESD and overcurrent protection**

Table 6. HDMI\_5V0\_CON

 $T_{amb}$  = -25 °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
r <sub>dyn</sub>	dynamic resistance	TLP	[1]				
		positive transient		-	1.0	-	Ω
		negative transient		-	1.0	-	Ω
V <sub>CL</sub>	clamping voltage	100 ns TLP; 50 Ω pulser at 50 ns		-	8	-	V
I <sub>O(max)</sub>	maximum output current	$V_{(HDMI_5V0_CON)} = 4.8 \text{ V}$		55	-	-	mA
I <sub>bck</sub>	back current	$V_{CC(5V0)} < V_{(HDMI\_5V0\_CON)}$		-	-	10	μΑ
I <sub>O(sc)</sub>	short-circuit output current	$V_{(HDMI\_5V0\_CON)} = 0 V$		-	125	175	mA
$V_{do}$	dropout voltage	4.5 V < V <sub>CC(5V0)</sub> < 4.925 V; DDC = LOW	[2]				
		I <sub>O</sub> = 10 mA		-	70	-	mV
		I <sub>O</sub> = 55 mA		-	-	125	mV
V <sub>O(LDO)</sub>	LDO output voltage	$I_{O} \le 55$ mA; 4.925 V < $V_{CC(5V0)}$ < 6.5 V; DDC = LOW	[2]	4.8	5.05	5.3	V

<sup>[1]</sup> ANSI-ESD SP5.5.1-2004, ESD sensitivity testing TLP component level method 50 TDR.

Table 7. UTILITY\_CON

 $T_{amb} = -25$  °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supplies:	pins V <sub>CC(5V0)</sub> and V <sub>CC(SYS)</sub>					
r <sub>dyn</sub>	dynamic resistance	TLP U				
		positive transient	-	1.0	-	Ω
		negative transient	-	1.0	-	Ω
V <sub>CL</sub>	clamping voltage	100 ns TLP; 50 Ω pulser at 50 ns	-	8.0	-	V
C <sub>i</sub>	input capacitance	$\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(SYS)} = 0 \text{ V; } V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$	-	8.0	10	pF
R <sub>pd</sub>	pull-down resistance		60	100	140	kΩ

<sup>[1]</sup> ANSI-ESD SP5.5.1-2004, ESD sensitivity testing TLP component level method 50 TDR.

<sup>[2]</sup> The IP4786CZ32S contains a 5 V voltage regulator function for higher input voltages. Any input voltage of  $4.925 \text{ V} < V_{CC(5V0)} < 6.50 \text{ V}$  provides HDMI-compliant output levels of 4.8 V to 5.3 V on HDMI\_5V0\_CON.

# **DVI and HDMI interface ESD and overcurrent protection**

Table 8. Static characteristics

 $T_{amb}$  = -25 °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
DDC buff	er on connector side[1]					
V <sub>IH</sub>	HIGH-level input voltage		$\begin{matrix} 0.5 \times \\ V_{(HDMI\_5V0\_CON)} \end{matrix}$	-	6.5	V
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	$\begin{array}{c} 0.3 \times \\ V_{(HDMI\_5V0\_CON)} \end{array}$	V
V <sub>OH</sub>	HIGH-level output voltage	[2]	V <sub>(HDMI_5V0_CON)</sub> - 0.02	-	V <sub>(HDMI_5V0_CON)</sub> + 0.02	V
V <sub>OL</sub>	LOW-level output voltage	internal pull-up and external sink	-	100	200	mV
V <sub>IK</sub>	input clamping voltage	$I_I = -18 \text{ mA}$	-	-	-1.0	٧
C <sub>IO</sub>	input/output capacitance	$V_{CC(5V0)} = 5.0 \text{ V};$ [2]3] $V_{CC(5YS)} = 3.3 \text{ V};$ CEC_STBY = HIGH	-	8.0	10	pF
R <sub>pu</sub>	pull-up resistance		1.6	1.8	2.0	kΩ
DDC buff	er on system side[1][4]					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC(SYS)} = 1.8 \text{ V}$	450	-	-	mV
		V <sub>CC(SYS)</sub> = 2.5 V	620	-	-	mV
		$V_{CC(SYS)} = 3.3 \text{ V}$	760	-	-	mV
		$V_{CC(SYS)} = 5.0 \text{ V}$	800	-	-	mV
$V_{IL}$	LOW-level input voltage	$V_{CC(SYS)} = 1.8 \text{ V}$	-	-	330	mV
		V <sub>CC(SYS)</sub> = 2.5 V	-	-	380	mV
		$V_{CC(SYS)} = 3.3 \text{ V}$	-	-	400	mV
		$V_{CC(SYS)} = 5.0 \text{ V}$	-	-	420	mV
V <sub>OH</sub>	HIGH-level output voltage	[2]	$V_{\text{CC(SYS)}} - 0.02$	-	V <sub>CC(SYS)</sub> + 0.02	V
V <sub>OL</sub>	LOW-level output voltage	$V_{CC(SYS)} = 1.8 \text{ V}$ [5]	-	490	500	mV
		$V_{CC(SYS)} = 2.5 \text{ V}$ [5]	-	640	690	mV
		$V_{CC(SYS)} = 3.3 \text{ V}$ [5]	-	685	790	mV
		$V_{CC(SYS)} = 5.0 \text{ V}$ [5]	-	720	820	mV
$V_{IK}$	input clamping voltage	$I_I = -18 \text{ mA}$	-	-	-1.0	V
C <sub>IO</sub>	input/output capacitance	$\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(SYS)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$	-	6.0	8.0	pF
R <sub>pu</sub>	pull-up resistance		3.2	3.65	4.1	kΩ

# **DVI and HDMI interface ESD and overcurrent protection**

**Table 8.** Static characteristics ... continued  $T_{amb} = -25$  °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
CEC_CO	N[1]					
V <sub>IH</sub>	HIGH-level input voltage		2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage		-	-	0.80	V
V <sub>OH</sub>	HIGH-level output voltage		2.88	3.3	3.63	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = 1.5 mA	-	100	200	mV
C <sub>IO</sub>	input/output capacitance	$\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(SYS)} = 0 \text{ V;} \\ &V_{bias} = 1.65 \text{ V;} \\ &AC \text{ input} = 2.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$	l -	8.0	10	pF
$R_{pu}$	pull-up resistance		23.4	26.0	28.6	kΩ
CEC_SYS	S[1][4]					
$V_{IH}$	HIGH-level input voltage	$V_{CC(SYS)} = 1.8 \text{ V}$	450	-	-	mV
		$V_{CC(SYS)} = 2.5 \text{ V}$	620	-	-	mV
		$V_{CC(SYS)} = 3.3 \text{ V}$	760	-	-	mV
		$V_{CC(SYS)} = 5.0 \text{ V}$	800	-	-	mV
$V_{IL}$	LOW-level input voltage	$V_{CC(SYS)} = 1.8 \text{ V}$	-	-	330	mV
		$V_{CC(SYS)} = 2.5 \text{ V}$	-	-	380	mV
		$V_{CC(SYS)} = 3.3 \text{ V}$	-	-	400	mV
		$V_{CC(SYS)} = 5.0 \text{ V}$	-	-	420	mV
$V_{OH}$	HIGH-level output voltage	[2	00(010)	-	$V_{CC(SYS)} + 0.02$	V
$V_{OL}$	LOW-level output voltage	$V_{CC(SYS)} = 1.8 \text{ V}$		490	500	mV
		$V_{CC(SYS)} = 2.5 \text{ V}$		640	690	mV
		$V_{CC(SYS)} = 3.3 \text{ V}$		675	770	mV
		$V_{CC(SYS)} = 5.0 \text{ V}$		710	800	mV
C <sub>IO</sub>	input/output capacitance	$\begin{split} &V_{CC(5V0)} = 0 \text{ V}; \\ &V_{CC(5YS)} = 0 \text{ V}; \\ &V_{bias} = 1.65 \text{ V}; \\ &AC \text{ input} = 2.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$	l -	6.0	7.0	pF
R <sub>pu</sub>	pull-up resistance		8.5	10	11.5	kΩ
HOTPLU	G_DET_CON[1]					
V <sub>IH</sub>	HIGH-level input voltage		2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage		-	-	0.8	V
R <sub>pd</sub>	pull-down resistance		60	100	140	kΩ
C <sub>i</sub>	input capacitance	$\begin{split} &V_{CC(5V0)} = 0 \text{ V;} \\ &V_{CC(SYS)} = 0 \text{ V;} \\ &V_{bias} = 2.5 \text{ V;} \\ &AC \text{ input} = 3.5 \text{ V}_{(p-p)}; \\ &f = 100 \text{ kHz} \end{split}$	l  -	8.0	10	pF

#### **DVI and HDMI interface ESD and overcurrent protection**

#### Table 8. Static characteristics ... continued

 $T_{amb}$  = -25 °C to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
HOTPLUG	DET_SYS[1]					
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OL</sub> = 1 mA	$0.7 \times V_{CC(SYS)}$	-	-	٧
V <sub>OL</sub>	LOW-level output voltage	$I_{OL} = -1 \text{ mA}$	-	200	300	mV
R <sub>pd</sub>	pull-down resistance		60	100	140	kΩ

- [1] The device is active if the input voltage at pin CEC\_STBY is above the HIGH level.
- [2] This parameter is guaranteed by design.
- [3] Capacitive load measured at power-on.
- [4] No external pull-up resistor attached.
- [5] Typical value at  $T_{amb} = +25$  °C.

#### Table 9. CEC\_STBY power management circuit

 $V_{CC(SYS)} = 1.62 \text{ V}$  to 5.5 V;  $V_{CC(5V0)} = 4.5 \text{ V}$  to 6.5 V; GND = 0 V;  $T_{amb} = -25 \text{ °C}$  to +85 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Board side:	input pin CEC_STBY[1]				·	·	·
V <sub>IH</sub>	HIGH-level input voltage	HIGH = active	[2]	1.2	-	6.5	V
V <sub>IL</sub>	LOW-level input voltage	LOW = standby	[3]	-0.5	-	0.8	V
R <sub>pd</sub>	pull-down resistance			60	100	140	kΩ
Ci	input capacitance	$V_I = 3 V \text{ or } 0 V$		-	6	7	рF

- [1] The CEC\_STBY pin should be connected permanently to V<sub>CC(5V0)</sub> or V<sub>CC(SYS)</sub> if no enable control is needed.
- [2] DDC buffers, HPD buffer, and HDMI\_5V0\_CON out enabled; CEC buffer enabled.
- [3] DDC buffers, HPD buffer, and HDMI\_5V0\_CON out disabled; CEC buffer enabled.

#### **DVI and HDMI interface ESD and overcurrent protection**

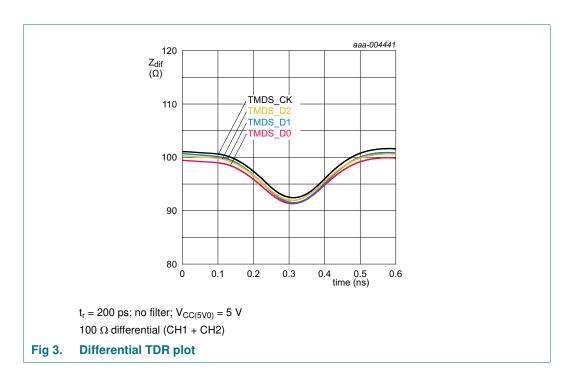
# 9. Dynamic characteristics

Table 10. Dynamic characteristics

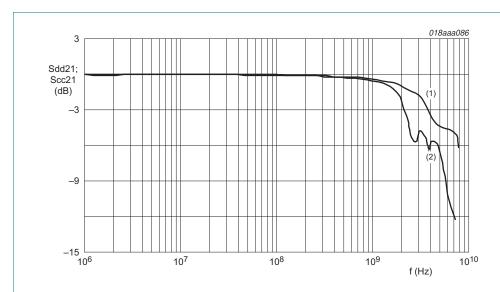
 $V_{CC(5V0)} = 5.0 \text{ V}; V_{CC(SYS)} = 1.8 \text{ V}; \text{GND} = 0 \text{ V}; T_{amb} = -25 \text{ °C to } +85 \text{ °C unless otherwise specified}.$ 

Symbol	Parameter	Conditions		Тур	Max	Unit				
DDC_DAT_SYS, DDC_CLK_SYS, DDC_DAT_CON, DDC_CLK_CON[1]										
t <sub>PLH</sub>	LOW to HIGH propagation delay	system side to connector side Figure 16	-	80	-	ns				
t <sub>PHL</sub>	HIGH to LOW propagation delay	system side to connector side Figure 16	-	60	-	ns				
t <sub>PLH</sub>	LOW to HIGH propagation delay	connector side to system side Figure 17	-	120	-	ns				
t <sub>PHL</sub>	HIGH to LOW propagation delay	connector side to system side Figure 17	-	80	-	ns				
t <sub>TLH</sub>	LOW to HIGH transition time	connector side Figure 18	-	150	-	ns				
t <sub>THL</sub>	HIGH to LOW transition time	connector side Figure 18	-	100	-	ns				
t <sub>TLH</sub>	LOW to HIGH transition time	system side Figure 19	-	250	-	ns				
t <sub>THL</sub>	HIGH to LOW transition time	system side Figure 19	-	80	-	ns				

[1] All dynamic measurements are done with a 75 pF load. Rise times are determined by internal pull-up resistors.



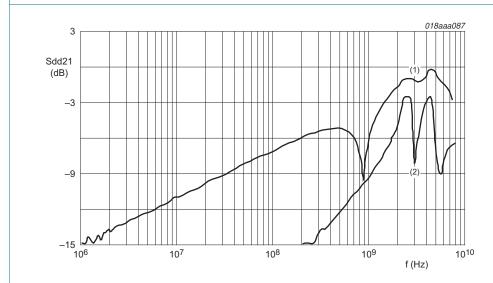
#### **DVI and HDMI interface ESD and overcurrent protection**



- (1) Sdd21
- (2) Scc21

Normalized to 100  $\Omega$ ; differential pairs at signal pins.

Fig 4. Mixed-mode differential and common-mode insertion loss; typical values

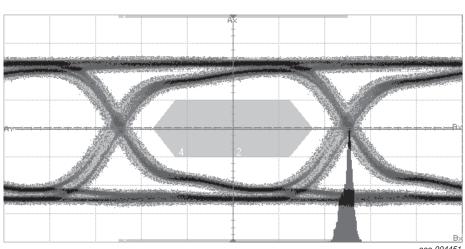


- (1) Sdd21; Near End Crosstalk (NEXT)
- (2) Sdd21; Far End Crosstalk (FEXT) normalized to 100  $\Omega$ ; differential pairs CH1/CH2 versus CH3/CH4

Fig 5. Mixed-mode differential and common-mode NEXT / FEXT; typical values

IP4786CZ32S **NXP Semiconductors** 

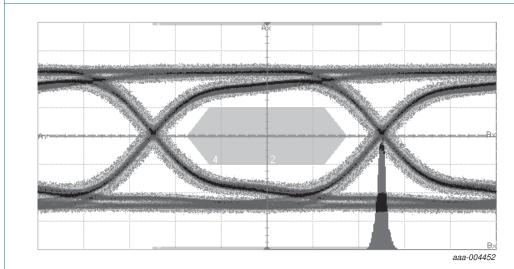
### **DVI and HDMI interface ESD and overcurrent protection**



aaa-004451

227 MHz pixel clock Horizontal scale: 90 ps/div Vertical scale: 200 mV/div Offset: 42.6 mV

Fig 6. Eye diagram using IP4786CZ32S (1080p, 12 bit)

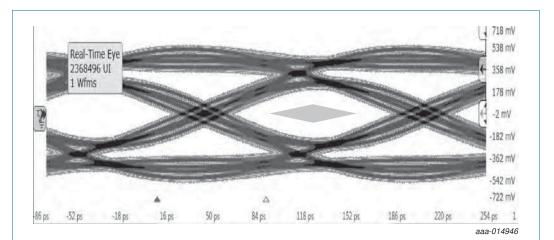


297 MHz pixel clock Horizontal scale: 67.5 ps/div Vertical scale: 200 mV/div

Offset: 42.6 mV

Eye diagram using IP4786CZ32S (1080p, 16 bit) Fig 7.

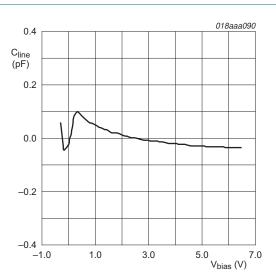
#### **DVI and HDMI interface ESD and overcurrent protection**



148.5 MHz test frequency

Measured at TP2 with worst cable emulator, reference cable equalizer and worst case negative skew, device powered.

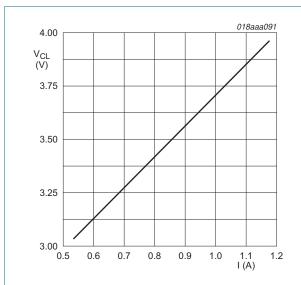
Fig 8. Eye diagram using IP4786CZ32S (2160p, 60 Hz)



Deviation from typical capacitance normalized at  $V_{\text{bias}} = 2.5 \text{ V}$ 

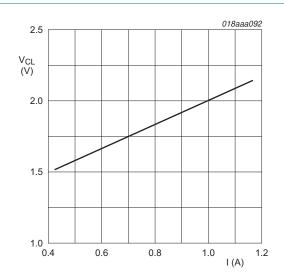
Fig 9. Line capacitance as a function of bias voltage; typical values

#### **DVI and HDMI interface ESD and overcurrent protection**



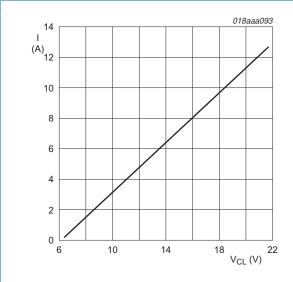
IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; positive pulse

Fig 10. Dynamic resistance with positive clamping



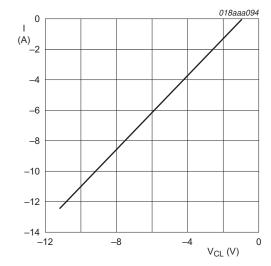
IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; negative pulse

Fig 11. Dynamic resistance with negative clamping



t<sub>p</sub> = 100 ns; TLP; signal pins; typical values

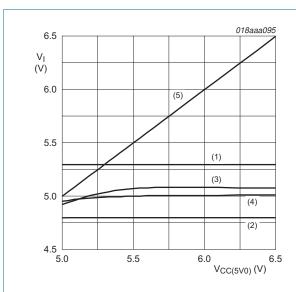
Fig 12. Dynamic resistance with positive clamping



 $t_p = 100 \text{ ns}$ ; TLP; signal pins; typical values

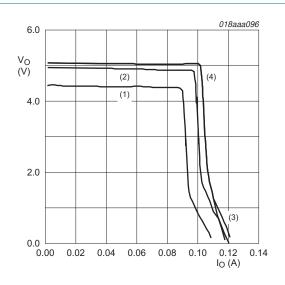
Fig 13. Dynamic resistance with negative clamping

# **DVI and HDMI interface ESD and overcurrent protection**



- (1) 5.3 V; maximum values; HDMI CTS TID 7-11
- (2) 4.8 V; minimum values; HDMI CTS TID 7-11
- (3) I = 0 mA
- (4) I = 55 mA
- (5)  $V_{CC(5V0)}$  supply input; 4.925 V to 6.5 V





- (1)  $V_{CC(5V0)} = 4.5 \text{ V}$
- (2)  $V_{CC(5V0)} = 5.0 \text{ V}$
- (3)  $V_{CC(5V0)} = 5.5 \text{ V}$
- (4)  $V_{CC(5V0)} = 6.5 \text{ V}$

Fig 15. Overcurrent limiter function (HDMI\_5V0\_CON)

#### **DVI and HDMI interface ESD and overcurrent protection**

# 10. AC waveforms

# 10.1 DDC propagation delay

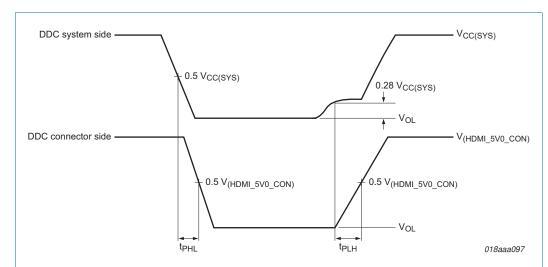


Fig 16. Propagation delay DDC, DDC system side to DDC connector side

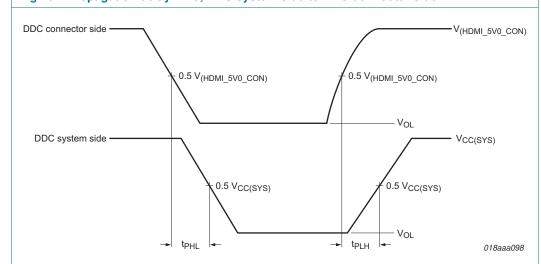
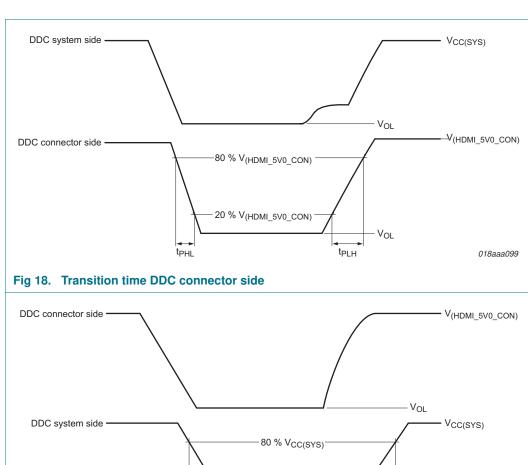


Fig 17. Propagation delay DDC, DDC connector side to DDC system side

### **DVI and HDMI interface ESD and overcurrent protection**

# 10.2 DDC transition time



20 % V<sub>CC(SYS)</sub>

 $t_{\mathsf{PLH}}$ 

Fig 19. Transition time DDC system side

t<sub>PHL</sub>

018aaa100

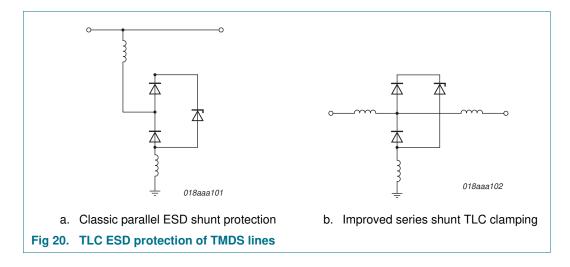
#### **DVI and HDMI interface ESD and overcurrent protection**

# 11. Application information

#### 11.1 TMDS ESD

To protect the TMDS lines and also to comply with the impedance requirements of the HDMI specification, the IP4786CZ32S provides ESD protection with matched TLC ESD structures. Typical Dual Rail Clamp (DRC) or rail-to-rail shunt structures are common for low-capacitance ESD protection (Figure 20; left side) where the dominant factor for the TMDS line impedance dip is determined by the capacitive load to ground. Parasitic lead inductances of the packaging in this case work against the ESD clamping performance by including the  $\Delta I/\Delta t$  reactance of the inductance into the path of the ESD shunt.

The IP4786CZ32S utilizes these inherent inductances in series with the transmission line in order to present an effective capacitive load of roughly only 0.7 pF. This TLC structure minimizes the capacitive dip, for ideal signal integrity (Figure 20; right side) without complicated PCB pre-compensation. As a beneficial side effect, this enhances the ESD performance of the device as well, since the reactance of the series inductance attenuates the fast initial peak of the ESD pulse, for a lower residual pulse delivered to the Application Specific Integrated Circuit (ASIC).



#### **DVI and HDMI interface ESD and overcurrent protection**

### 11.2 Operating and standby modes

The operating mode of IP4786CZ32S depends on the availability of the  $V_{CC(5V0)}$  and  $V_{CC(SYS)}$  supply voltages and on the state of the CEC\_STBY input signal. Without availability of both supplies, IP4786CZ32S is in Standby mode. As soon as  $V_{CC(5V0)}$  and  $V_{CC(SYS)}$  are within the range specified in Section 8, the part is in an operating mode that can be controlled via the CEC\_STBY input signal. In case CEC\_STBY is LOW, only the CEC buffer is active and enabled to receive or send CEC commands. All other outputs are in a high-ohmic state. A HIGH input signal enables all parts of IP4786CZ32S and puts the device into full operating mode.

Table 11. IP4786CZ32S operating modes

V <sub>CC(SYS)</sub>	V <sub>CC(5V0)</sub>	CEC_STBY[1]	Mode	Description
< 1.1 V	< 4.5 V	X	Standby mode	all outputs high-ohmic
≥ 1.1 V	≥ 4.5 V	L	CEC Standby mode	CEC circuit active; all other outputs high-ohmic
		Н	full operating mode	all functional blocks active

[1] X = Don't care (either LOW or HIGH level); L = LOW-level input; H = HIGH-level input

If no CEC Standby mode is required, or if no special Power-down modes are desired, the CEC\_STBY pin can be pulled HIGH to  $V_{\text{CC}(5\text{V0})}$  or  $V_{\text{CC}(S\text{YS})}$  for continuous HDMI and CEC operation as soon as the supplies are available.

Strapping the CEC\_STBY =  $V_{CC(SYS)} = V_{DD}$  of the ASIC guarantees that all interface signals ending with the suffix "\_SYS" on the system side are disabled when  $V_{CC(SYS)}$  goes LOW. This configuration protects the ASIC I/O signals from exceeding its local  $V_{DD}$ . In this mode, even if  $V_{CC(5V0)}$  is powered, HDMI\_5V0\_CON goes active and hot plug events can be detected only when the ASIC power supply rail is on.

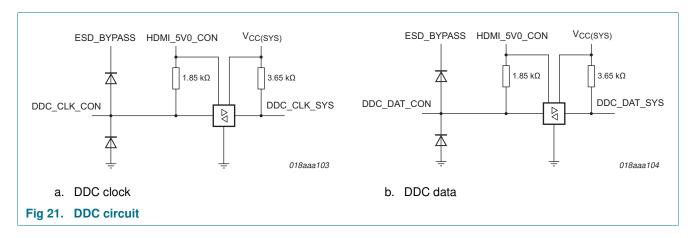
Strapping CEC\_STBY =  $V_{CC(5V0)}$  is the most basic configuration where the buffers are enabled whenever the local  $V_{CC(5V0)}$  and  $V_{CC(SYS)}$  supplies reach minimum operating levels.

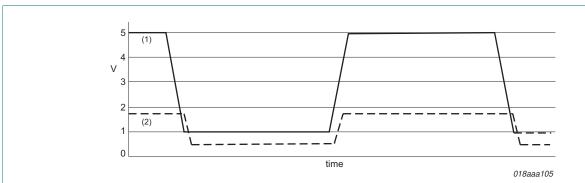
#### **DVI and HDMI interface ESD and overcurrent protection**

#### 11.3 DDC circuit

The DDC bus circuit integrates all required pull-ups, and provides full capacitive decoupling between the HDMI connector and the DDC bus lines on the PCB. The capacitive decoupling ensures that the maximum capacitive load is well within the 50 pF maximum of the HDMI specification. No external pull-ups or pull-downs are required.

The bidirectional buffers support high-capacitive load on the HDMI cable-side. Various non-compliant but prevalent low-cost cables have been observed with a capacitive load of up to 6 nF on the DDC lines, far exceeding the 700 pF HDMI limit. The IP4786CZ32S can easily decouple this from the weaker ASIC I/O buffers, and drive the rogue cable successfully.





- (1) Valid  $I^2C$  signaling example on the cable (connector side) from 5 V (HIGH) to approximately 1 V (LOW).
- (2) Valid logic-level signaling example to the ASIC (system side) from 1.8 V (HIGH) to approximately 0.5 V (LOW).

Fig 22. DDC level shifting waveform example

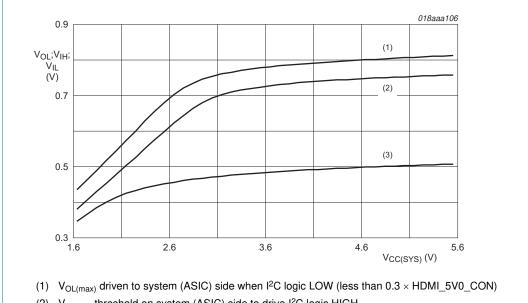
#### **DVI and HDMI interface ESD and overcurrent protection**

# 11.4 Logic low I<sup>2</sup>C voltage shifter

The DDC buffers provide an additional feature commonly required for high-integration HDMI ASICs. In order to be compatible with the 5 V I $^2$ C standard used for DDC communication, I/O buffer cells of many HDMI modern transmitter chips require level shifting. As FET-based level shifting just limits the HIGH level of the signal, the LOW level remains unchanged. As a result, the LOW-level voltages on the DDC bus often exceed the 0.3 VDD LOW-level input voltage (VIL) limit of low-voltage I/O buffers.

To enable proper operation that is independent of the system side I/O voltage, the DDC buffers inside IP4786CZ32S shift both the HIGH and the LOW levels by the required amount. This ensures that LOW levels on the system side DDC bus match the LOW-level input voltage requirements down to I/O voltages of 1.8 V.

Besides the DDC buffers, this feature is also included in the CEC buffer, allowing standard I/O buffer cells to be used in HDMI ASICs and microcontrollers.



- (2)  $V_{IH(min)}$  threshold on system (ASIC) side to drive I<sup>2</sup>C logic HIGH
- (3) V<sub>IL(max)</sub> threshold on system (ASIC) side to drive I<sup>2</sup>C logic LOW

Fig 23. Logic voltage thresholds as a function of supply voltage on system side

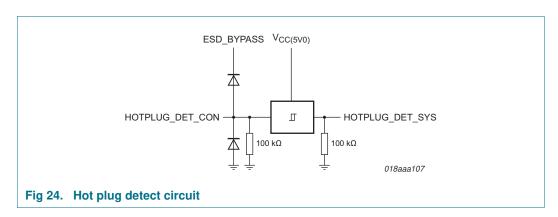
#### **DVI and HDMI interface ESD and overcurrent protection**

### 11.5 Hot plug detect circuit and HEAC support

The IP4786CZ32S includes a hot plug detect circuit that simplifies the hot plug application. The circuit generates a standard logic level from the hot plug signal.

The hot plug detect circuit is pulling down the signal to avoid any floating signal. The comparator guarantees a save detection of the 2 V hot plug signal without any glitches or oscillation at the hot plug output.

The IP4786CZ32S also provides an additional ESD pin to protect the reserved / HEAC pin along with hot plug detect to 12 kV IEC 61000-4-2, level 4.



#### 11.6 CEC

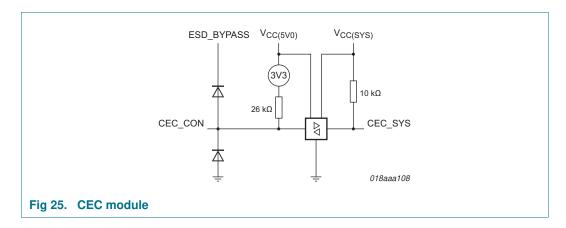
The logical multidrop topology of the CEC bus can include complex physical stubs, loading cables, and interconnects that may deteriorate signal quality. The IP4786CZ32S includes a full bidirectional buffer to drive the CEC bus and isolate the CEC microcontroller or ASIC General-Purpose Input/Output (GPIO).

The CEC buffer derives power from an on-board 3.3 V regulator from the  $V_{CC(5V0)}$  domain (see <u>Figure 25</u>). This allows extensive system power management configurations and guarantees an HDMI-compliant  $V_{(CEC\_CON)}$  on the connector, as well as the backdrive-protected 125  $\mu$ A nominal CEC pull-up which does not degrade the bus when powered down.

By placing the CEC microcontroller and  $V_{CC(5V0)}$  input on a 5 V rail as shown in <u>Figure 28</u>, the CEC microcontroller can communicate over CEC for power commands, and then enable the HDMI port via the CEC\_STBY pin, as well as the rest of the system as needed.

The CEC buffer is always active as soon as both supply voltages are present. For details on the operating and Standby modes of IP4786CZ32S, see Section 11.2.

# **DVI and HDMI interface ESD and overcurrent protection**



### 11.7 Backdrive protection

The HDMI connector contains various signals which can partly supply current into an HDMI device that is powered down.

Typically, the DDC lines and the CEC signals can force significant current back into the powered-down rails as shown in <a href="Figure 26">Figure 26</a>, causing power-on reset problems with the system, and possible damage. The IP4786CZ32S prevents this backdrive condition whenever the I/O voltage is greater than the local supply.

